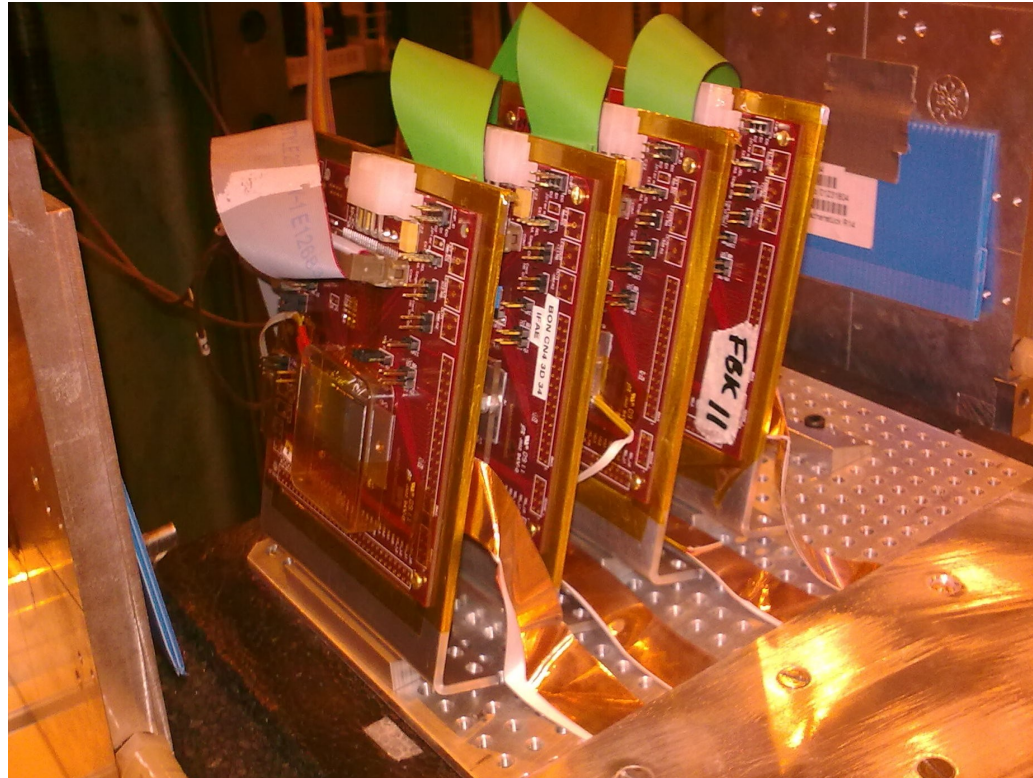


# Test-beam results of CNM 3D FE-I4 devices



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# Outline

- Overview of the Devices Under Test (DUT) used at June and September IBL test-beams at CERN.
- Results from June IBL Test-beam:
  - Overall Efficiency.
  - Pixel Map Efficiency.
  - Edge Efficiency.
- Threshold and HV studies from September IBL Test-beam:
  - Impact of the Threshold on the Efficiency.
  - Impact of the HV on the Efficiency.
  - Impact of the HV on the charge collection (ToT Spectrum).
- Results from September IBL test-beam:
  - Pixel Map Efficiency.
  - Position resolution.
- Conclusions

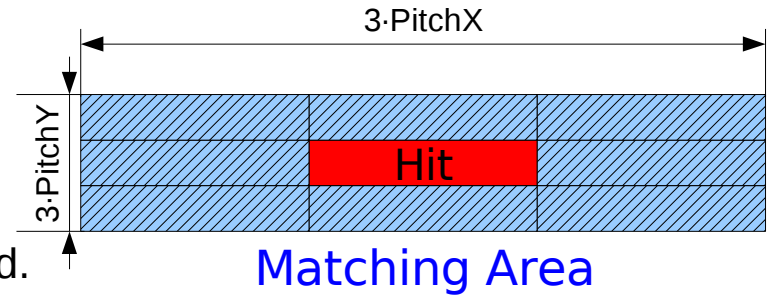
All results presented here are still preliminary!

## Devices overview

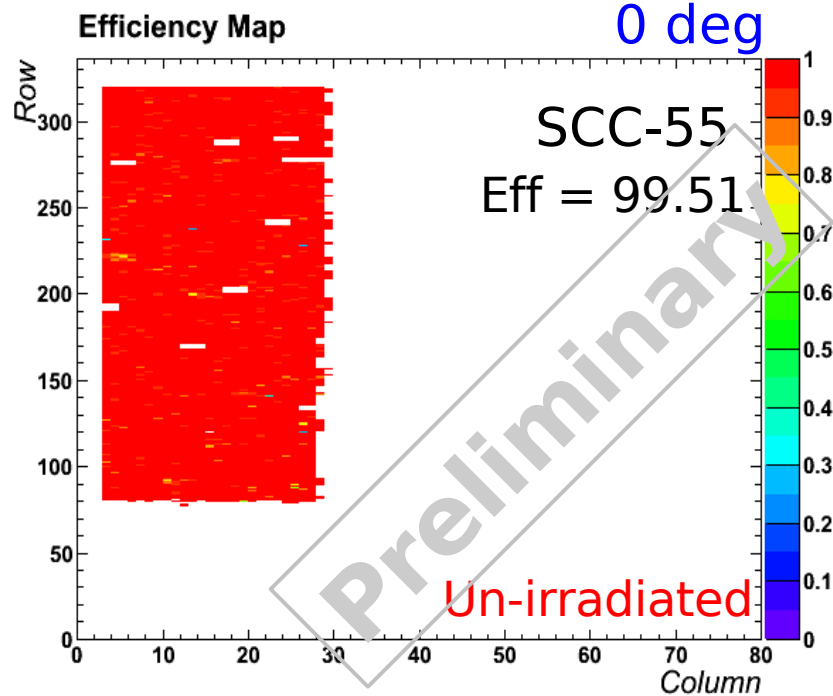
- All CNM 3D sensors used in the test-beams were:
  - Double sided process
  - P-bulk 230um thick , “2E-250” configuration ~210um columns
  - 3D guard ring + fence (200um inactive edge)
- Data were taken under 0 and 15 degrees to the beam.
- List of devices used at **June** test-beam:
  - (**SCC-55**) CNM\_3D\_08 **un-irradiated**
  - (**SCC-34**) CNM\_3D\_34 **p-irradiated** up to  $5 \cdot 10^{15}$  neq/cm<sup>2</sup>
  - (**SCC-82**) CNM\_3D\_35 **n-irradiated** up to  $5 \cdot 10^{15}$  neq/cm<sup>2</sup>
- List of devices used at **September** test-beam:
  - (**SCC-55**) CNM\_3D\_08 **un-irradiated**
  - (**SCC-34**) CNM\_3D\_34 **p-irradiated** up to  $5 \cdot 10^{15}$  neq/cm<sup>2</sup>
  - (**SCC-81**) CNM\_3D\_37 **n-irradiated** up to  $5 \cdot 10^{15}$  neq/cm<sup>2</sup>

# Hit Efficiency for CNM 3D FE-I4 devices (June TB)

$$\text{Efficiency} = \frac{\text{Number of Matched Tracks}}{\text{Number of Total Tracks}}$$



- requires at least one matched hit on any other DUT.
- hits nearby masked (**noisy** and **dead**) pixels are removed.

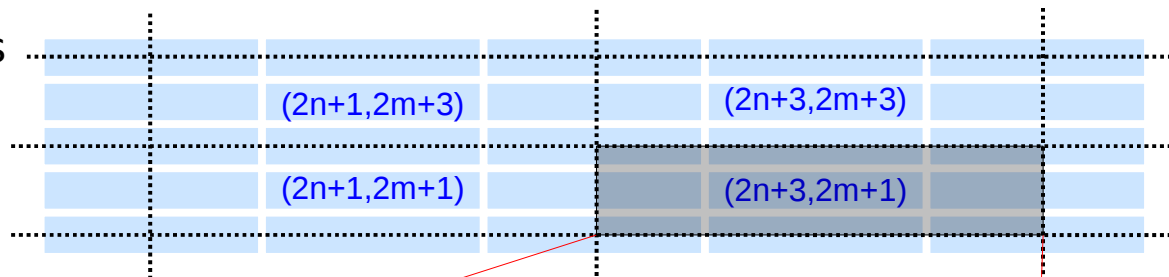


- SCC-55, 0deg, HV = 20V, Threshold = 1600e: Eff = 99.51%;
- SCC-34, 0deg, HV = 140V, Threshold = 3200e: Eff = 95.87%;
- CNM recommended 140V operation for irradiated sensors--> Low efficiency obtained
- Suggested that sensors were under biased.

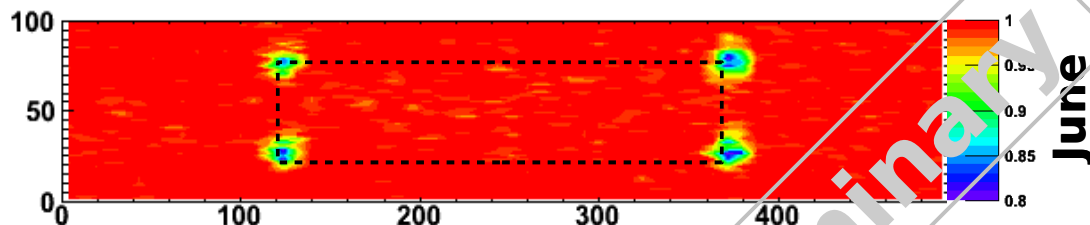
# Efficiency Pixel Maps for 3D devices (June TB)

Obtaining Efficiency Pixel map:

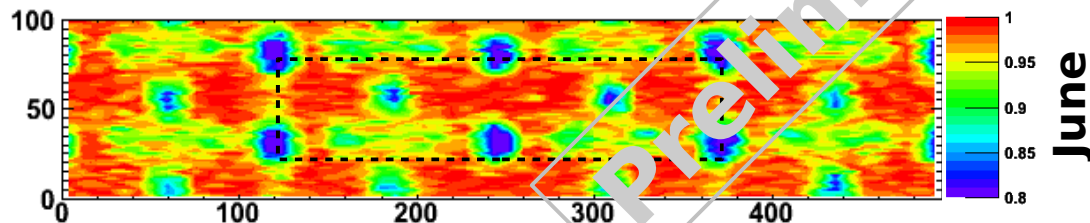
- Divide sensor on doubled blocks
- For each block construct:
  - Matched Tracks Map
  - Total Tracks Map.
- Sum up the maps of all blocks
- Calculate the ratio of the two aggregated maps



SCC55 (CNM-3D), HV=20V  
 Unirradiated, 0 degree  
 Threshold = 1600e, Eff=99.51



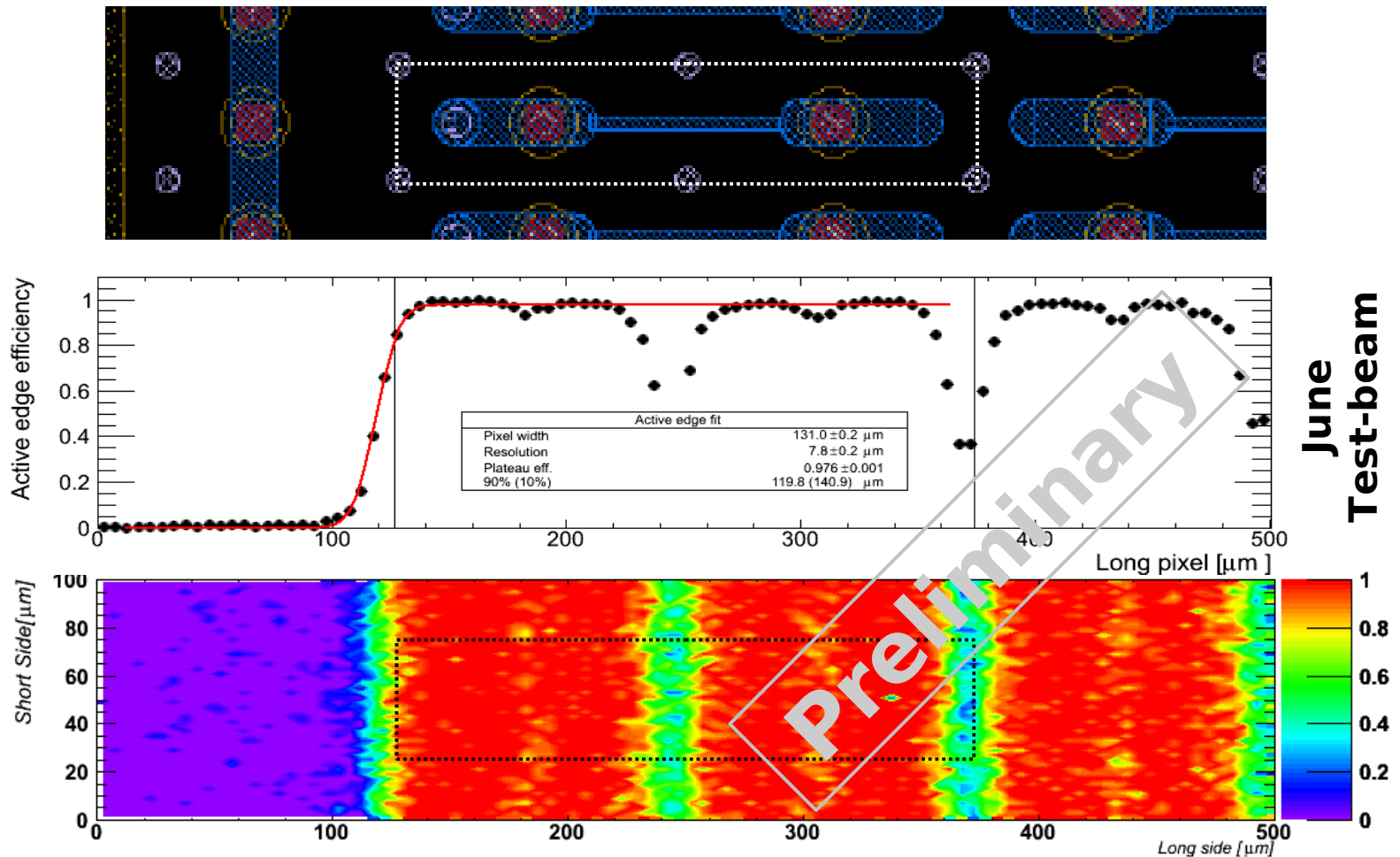
SCC34 (CNM-3D), HV=140V  
 p-irrad  $5 \times 10^{15}$ , 0 degree  
 Threshold = 3200e, Eff=95.87



- Low efficient areas associated to n+column were observed.

# Edge Pixel studies for CNM 82 device (June TB)

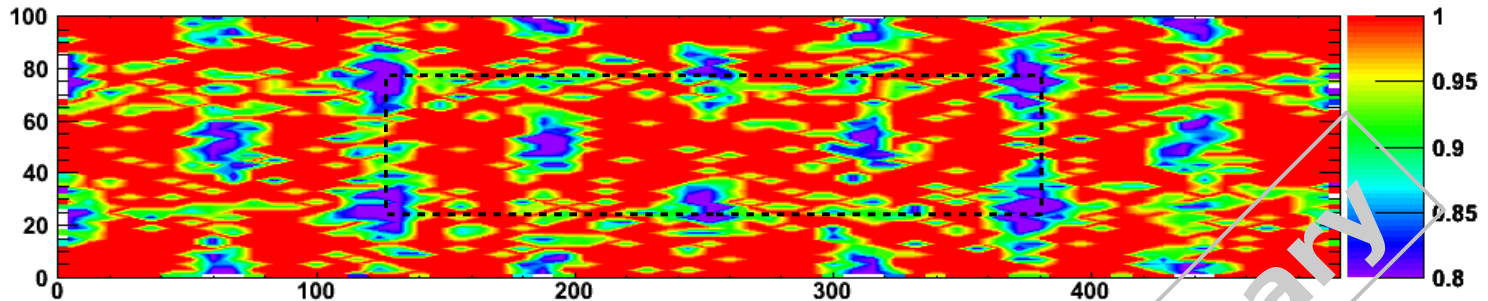
Very low efficiency for SCC82 (n-irradiated up to  $5E15\text{neq/cm}^2$ )



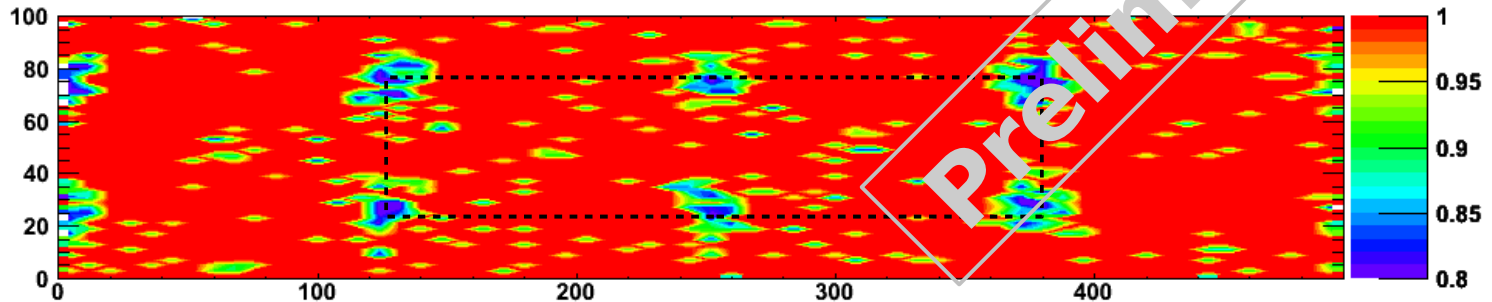
- Overall efficiency was about 90%
- device was under-biased (140V)
- inactive edge area of about 200μm.

# Efficiency studies for various Thresholds

SCC-34, 0deg, HV = 160V, Threshold = 3200e: Efficiency = 94.53



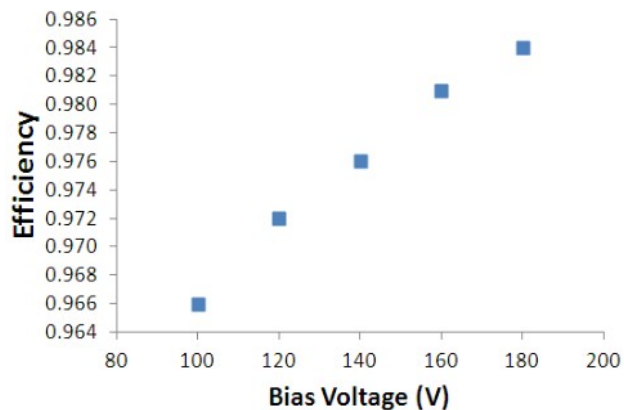
SCC-34, 0deg, HV = 160V, Threshold = 1500e: Efficiency = 98.10



- Inefficiency area associated to n+column disappears.
- Thresholds were NOT verified at the test-beam:
  - Can not fully trust the results above.
  - Temperature and geometry are the same.
- However, very likely lower threshold makes significant improvement on efficiency.

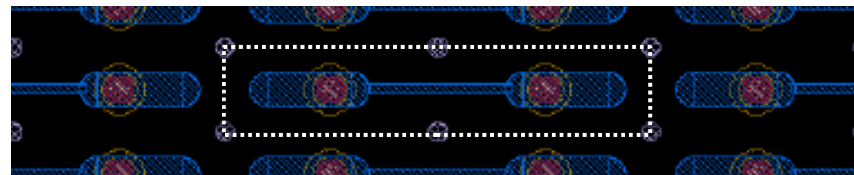
# Efficiency Pixel Maps for SCC34 for different HV

0 deg

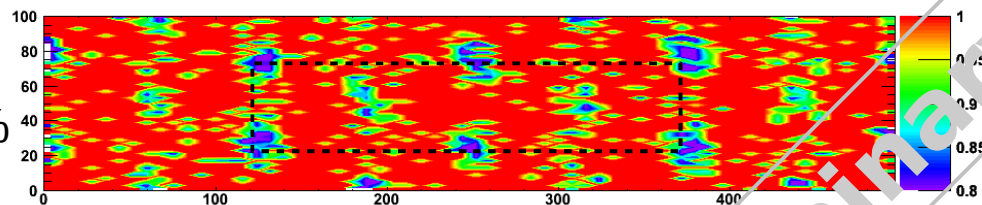


- At ~160V inefficiency area associated to n+column disappears

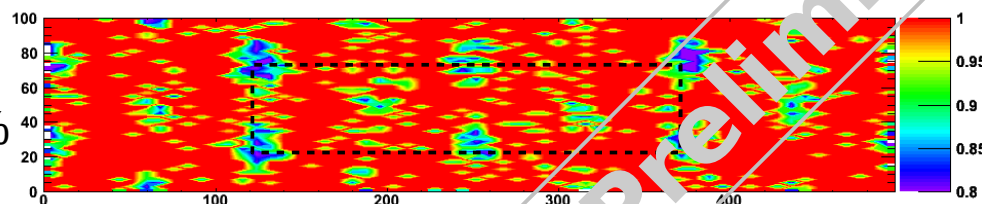
- Efficiency and charge collection increase beyond 160V (but no charge multiplication expected)



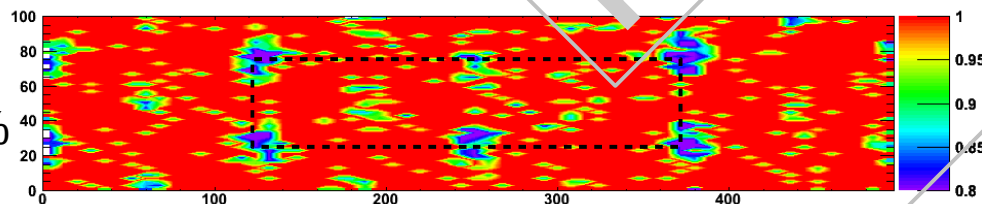
HV=100  
Eff=96.6%



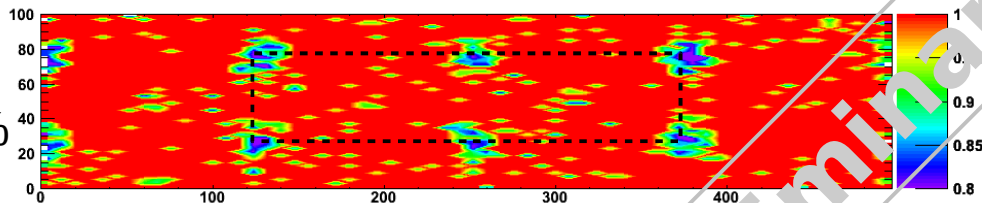
HV=120  
Eff=97.2%



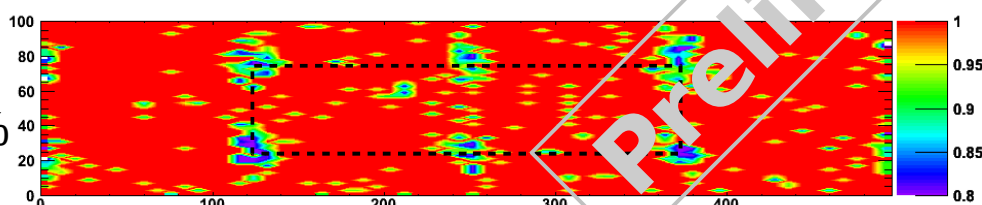
HV=140  
Eff=97.6%



HV=160  
Eff=98.1%

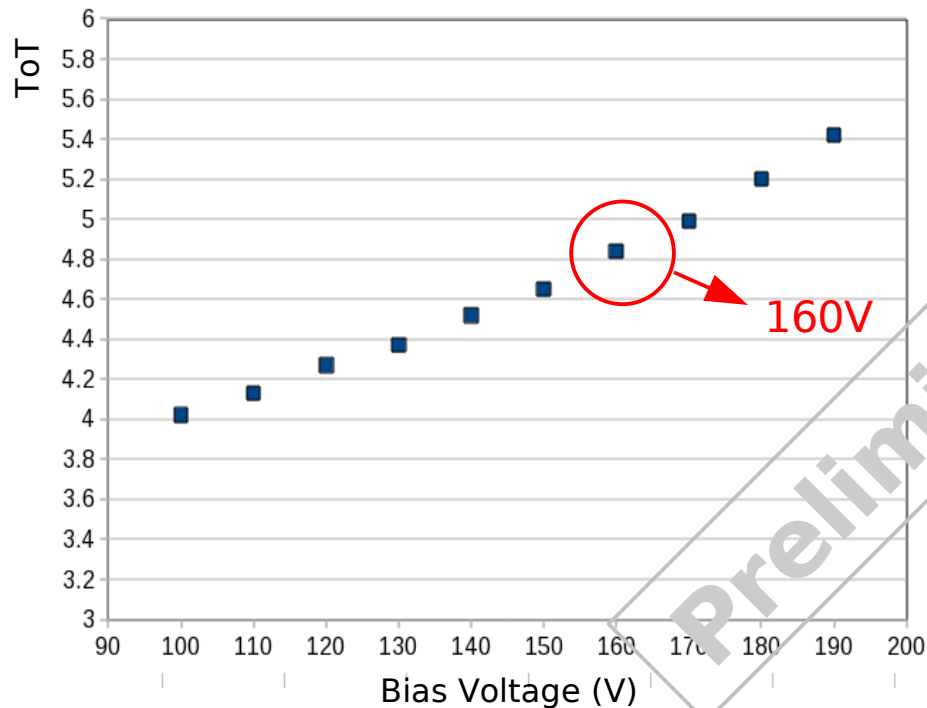


HV=180  
Eff=98.4%



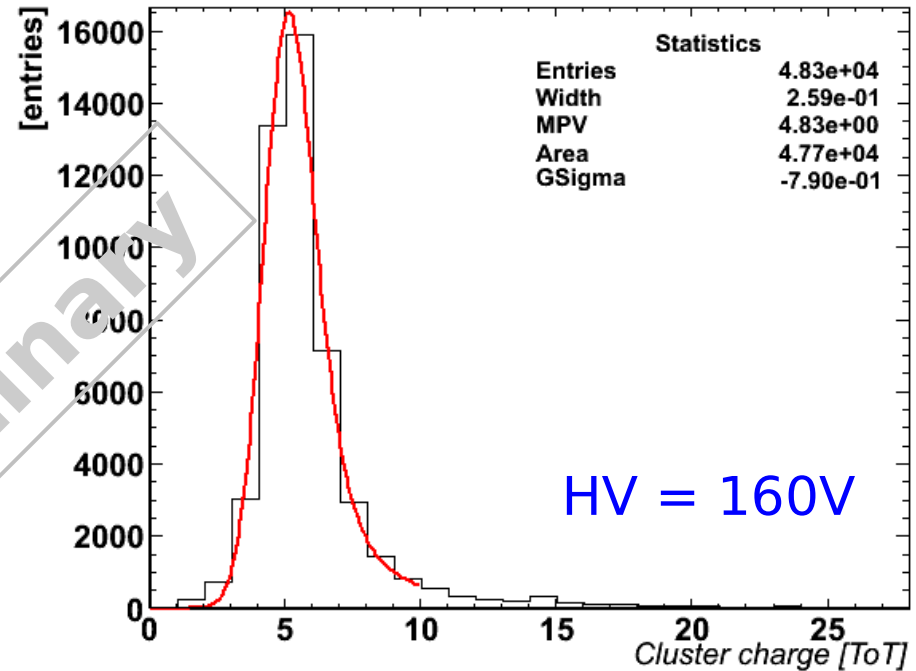


# Matched Cluster ToT spectrum for different HV



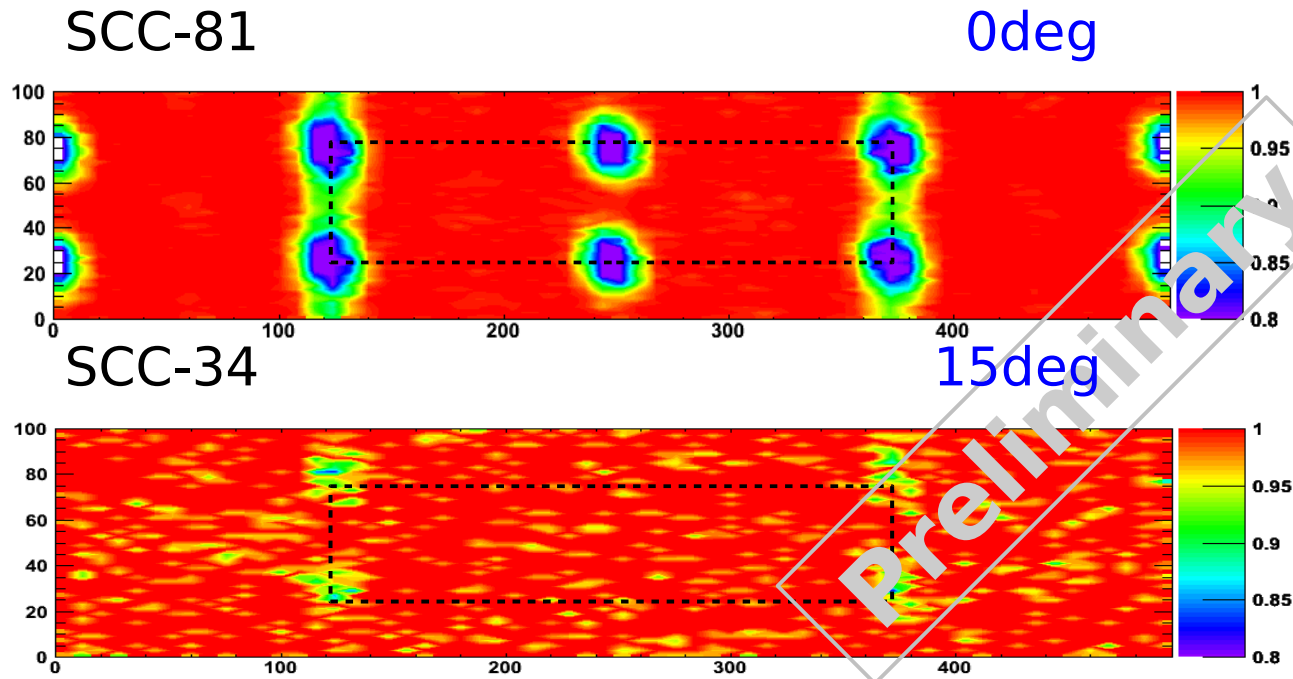
Tot distribution (matched).

SCC-34



- Improving charge collection with increasing Bias Voltage.
- Noise increases after 160V significantly. (see Ali Harb talk)
- Optimal voltage for SCC-34  $5E15\text{neq}/\text{cm}^2$  irradiated devices  $\sim 160\text{V}$

# Efficiency Pixel Maps for CNM 3D FE-I4 devices (Sep. TB)

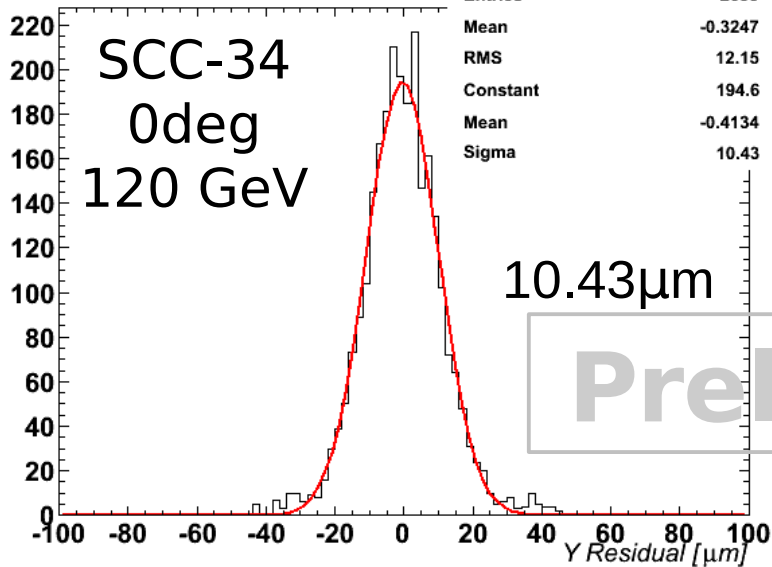


- SCC-81, 0deg, HV = 160V, Threshold = 1500e: Eff = 97.46%;
- SCC-34, 15deg, HV = 160V, Threshold = 1500e: Eff = 98.95%;
- Conclusions:
  - Electrode columns are “on/off” depending on angle, HV and Threshold.
  - CNM 3D FE-I4 devices perform according to IBL requirements in terms of efficiency: Efficiency > 97% for irradiated devices to  $5 \cdot 10^{15} \text{neq/cm}^2$ .

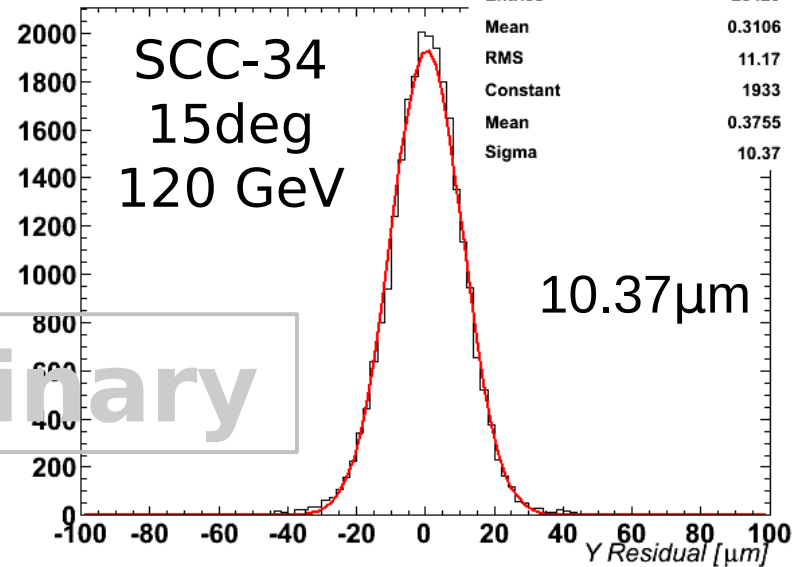
# Position Residuals for CNM 3D FE-I4 devices

$$\text{Residual.Y} = \text{Track.Y} - \text{ClusterCenter.Y}$$

22-cluSize2-resY



21-cluSize2-resY



- Position resolution estimated from residual distribution in 2-cluster hits include  $\sim 4\mu\text{m}$  telescope resolution.
- Position resolution for 0 and 15 degrees are the same

# Conclusions

- With operative voltage = 160V and Threshold = 1500e CNM 3D FE-I4 devices satisfy IBL requirements in terms of efficiency:
  - Efficiency > 97% (for irradiated devices to 5E15neq/cm<sup>2</sup>)
- More studies underway

**Thank you for  
your attention!**